



## GENERAL PURPOSE DIODE MODULE

### Features:

- . Electrical insulation between chip and base plate, 2500V AC insulation
- . Compress structure
- . Excellent temperature characteristics and power cycling capability
- . Small size & light weight

### Typical application:

- . AC / DC motor control
- . Various rectification power supplies
- . Excellent temperature characteristics and power cycling capability
- . Frequency converter



## ELECTRICAL CHARACTERISTICS AND RATINGS

Symbol	Parameter	Conditions	T <sub>j</sub> (°C)	Data			Unit
				Min	Typ	Max	
I <sub>T(AV)</sub>	Mean on-state current	Sinewave 180°,50Hz Single side cooling, T <sub>c</sub> =85°C	150			1200	A
I <sub>F(RMS)</sub>	RMS on-state current		150			1884	A
V <sub>RRM</sub>	Repetitive peak off-state voltage Repetitive peak reverse voltage	V <sub>DRM</sub> &V <sub>RRM</sub> tp=10ms V <sub>DSDM</sub> &V <sub>RSM</sub> =V <sub>DRM</sub> &V <sub>RRM</sub> +200V	150	800		1800	V
I <sub>RRM</sub>	Repetitive peak off-state current	V <sub>DM</sub> =V <sub>DRM</sub> V <sub>RM</sub> =V <sub>RRM</sub>	150			45	mA
I <sub>RRM</sub>	Repetitive peak reverse current						
I <sub>FSM</sub>	Surge on-state current	10ms bottom width, half sine wave V <sub>R</sub> =0.6V <sub>RRM</sub>	150			34	KA
I <sup>2</sup> t	I squared t					5780	A <sup>2</sup> s*10 <sup>3</sup>
V <sub>FO</sub>	On-state threshold voltage		150			0.71	V
r <sub>F</sub>	Slope resistance					0.11	mΩ
V <sub>FM</sub>	Peak on-state voltage	I <sub>FM</sub> =3000A	25			1.45	V
R <sub>th(j-c)</sub>	Thermal impedance(junction to case)	180°sine wave, Single side heat dissipation				0.040	°C /W
R <sub>th(c-h)</sub>	Thermal impedance(case to heatsink)	180°sine wave, Single side heat dissipation				0.020	°C /W
V <sub>iso</sub>	Insulation voltage	50Hz,R.M.S,t=1min,I <sub>iso</sub> :1mA(MAX)		2500			V
F <sub>m</sub>	Electrode mounting torque (M12)				14		N·m
	Base plate mounting torque (M8)				12		N·m
T <sub>stg</sub>	Storage temperature			-40		125	°C
W <sub>t</sub>	Weight				4050		g

**Jiangsu Runau Electronics Manufacturing Co.,Ltd**  
**GRAPH**

**MDC1200 MDA1200 MDK1200 MDX1200**

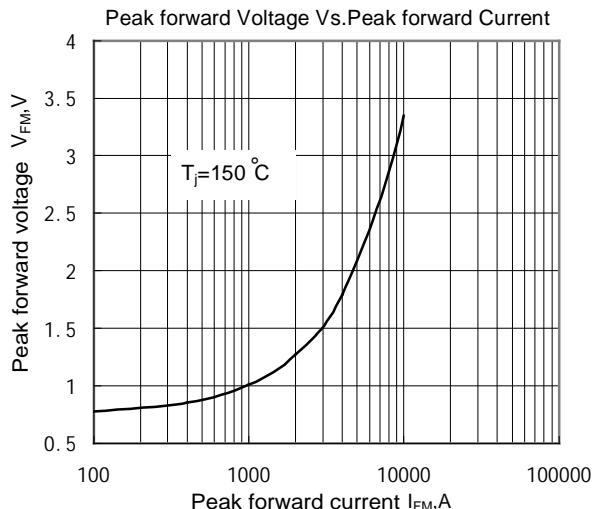


Fig.1 Forward Volt-ampere Characteristic Curve

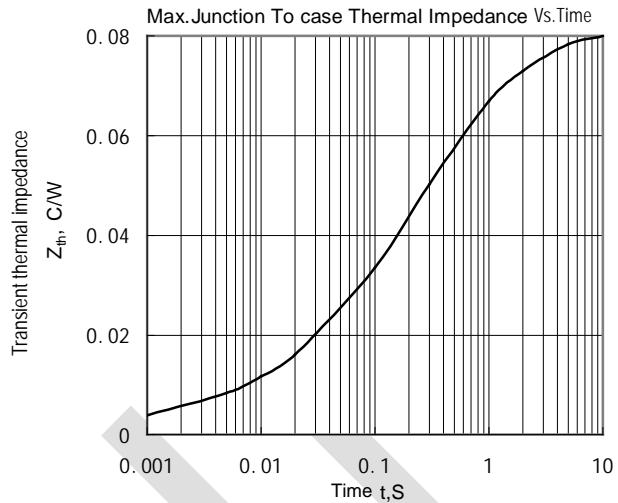


Fig.2 Transient Thermal Impedance Curve

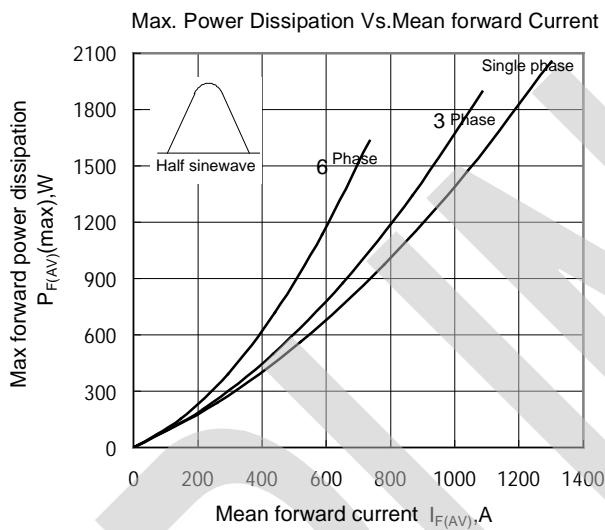


Fig.3 Max Power Dissipation Vs. Mean Forward Current

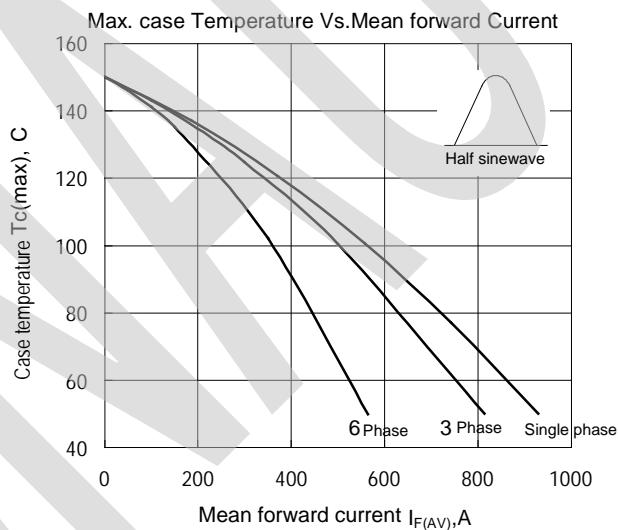


Fig.4 Max Case Temperature Vs. Mean Forward Current

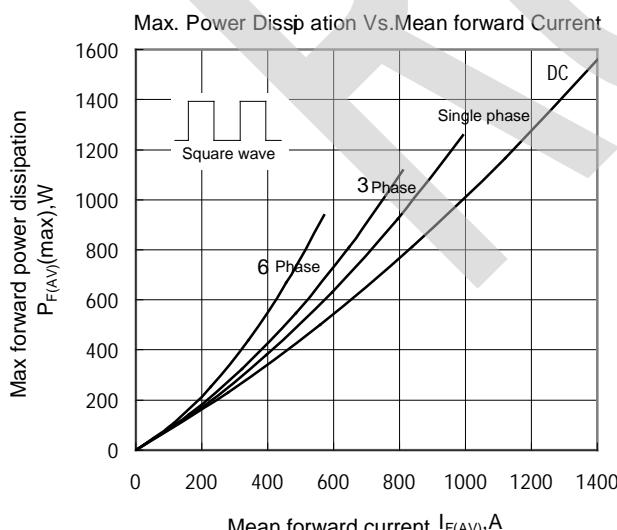


Fig.5 Max Power Dissipation Vs. Mean Forward Current

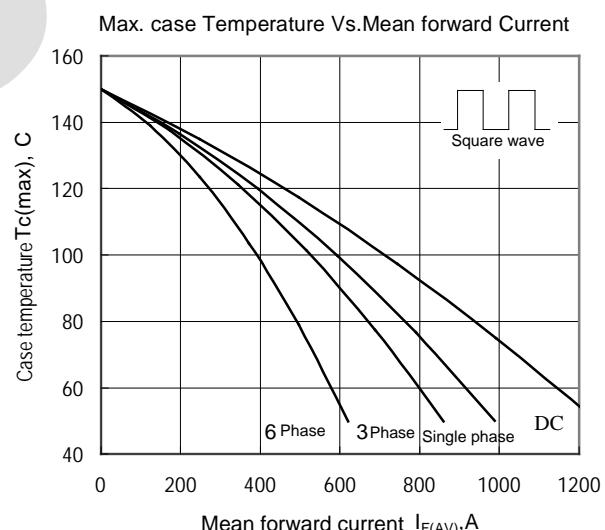


Fig.6 Max Case Temperature Vs. Mean Forward Current

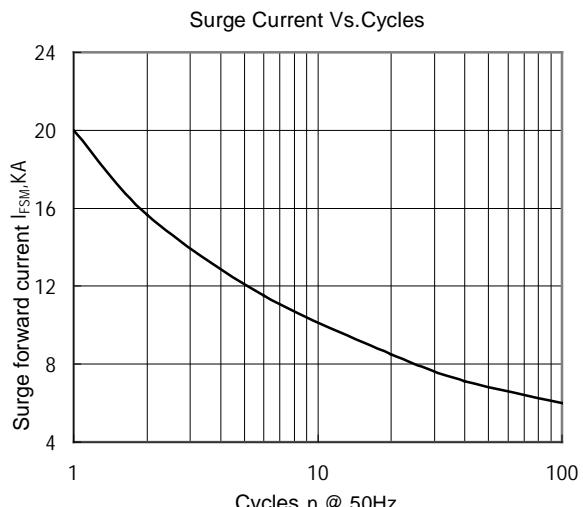


Fig.7 Surge Current Vs.Cycles

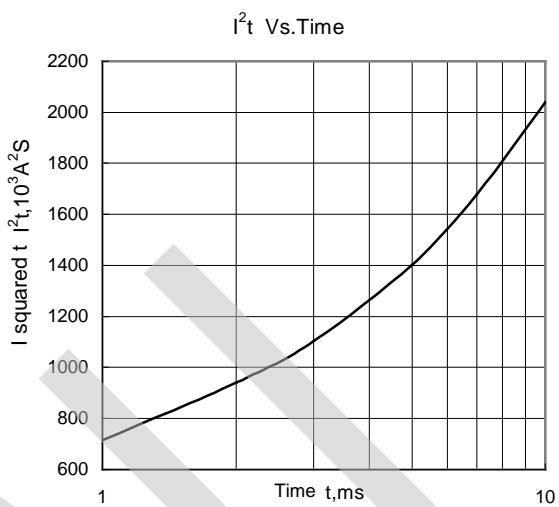
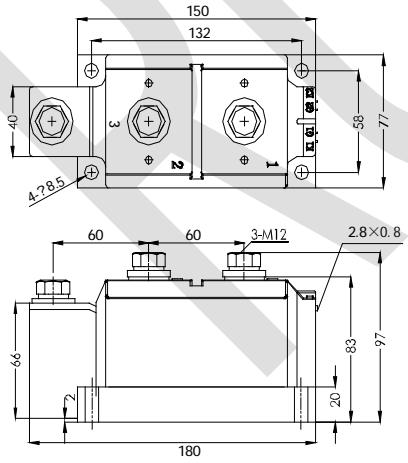


Fig.8  $I^2t$  Vs.Time

## OUTLINE



M477F

